

4D/5D technology for future trackers – Simone Mazza (UCSC)

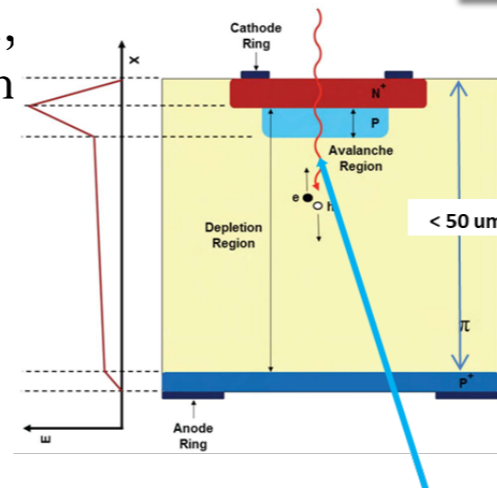
Need very small pixels:
(e.g. 50k pixels/cm²)

Thin sensors are required for
very good time resolution
Thin sensors need gain!

- **Basic research need (BRN) requirements for future trackers**
- Spatial resolution $\sim 5 \mu\text{m}$
- Temporal resolution $\sim 10 \text{ ps}$
- Very low material budget (sensor + elect. $< 100 \text{ mm}$ of silicon)
- Very low power consumption (air cooling $< 0.2 \text{ W/cm}^2$)

- Low-Gain avalanche detectors (**LGADs**)
 - **Example of blue-sky R&D** within RD50, AIDA, supported by the US DoE (UCSC), now also within US-Japan collaboration
- **Started in 2012**
 - In 2019/2020 **ATLAS** and **CMS** submitted TDRs for **large-scale timing upgrades** to suppress backgrounds using **LGADs** with area of $\sim 10 \text{ m}^2$
 - Now produced by >10 companies/labs
- **Issues:** granularity, radiation hardness, power dissipation

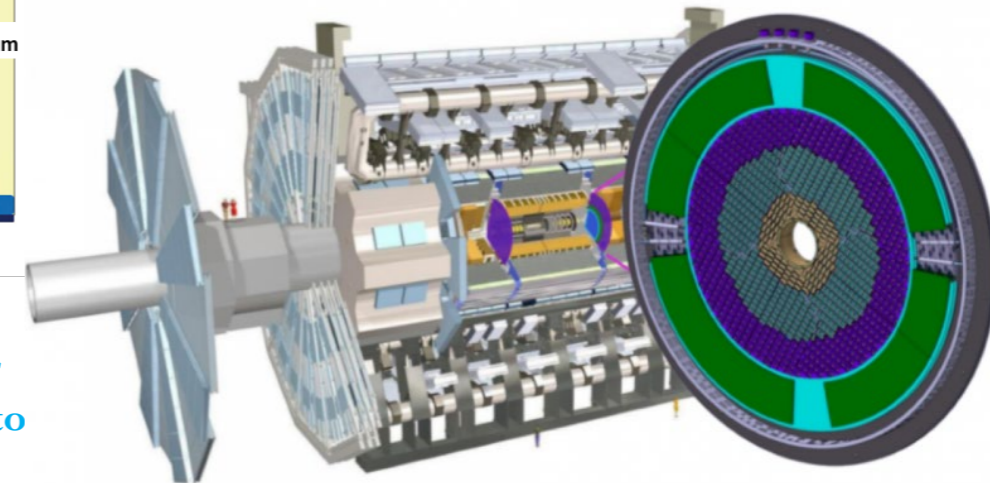
Good temporal resolution requires a lot of
power per pixel: minimize # of channels!



LGAD, Silicon sensor
with thin gain layer to
boost S/N

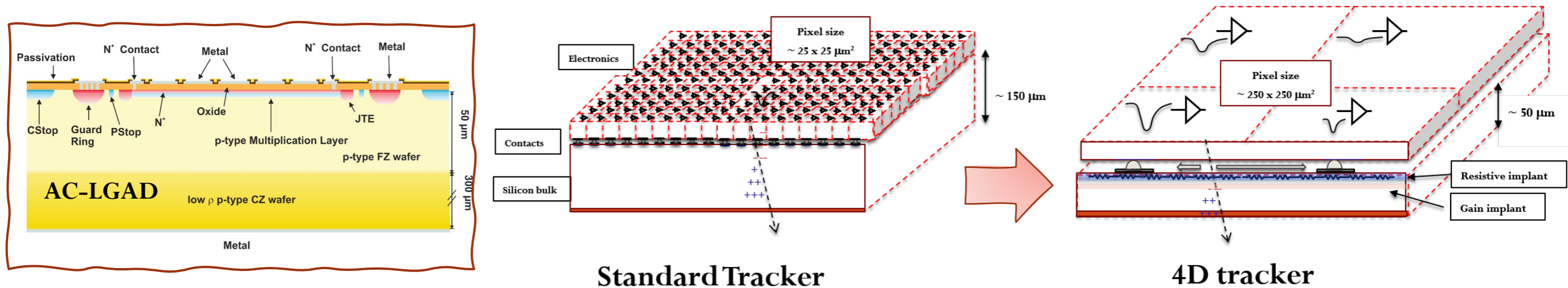
ATLAS HGTD

CMS ETL



4D devices – AC Low-gain avalanche detectors (AC-LGADs)

- Issues to solve: **low granularity** of traditional LGADs and **power dissipation**
 - Solution for both: **AC-coupled LGADs (AC-LGADs)**
- Continuous sheets of multiplication layer and resistive N⁺ layer, **AC-coupled readout**
 - **Collected charge is shared** between electrodes (**position resolution \ll pitch**)
- New concept: **sparse readout, high precision and low power**
 - Great time resolution from thin LGADs
 - Works in low occupancy environment, good for lepton colliders
- Upcoming AC-LGAD applications: the ePIC (@ EIC) and PIONEER (small-scale) experiments
 - **Next: Higgs factories**, technology optimization needed!



Long-term development of 4/5D LGAD detectors

- **New technology** needs to be developed for future colliders with **high radiation hardness requirements** (10^{16-17} Neq/cm²) and **high occupancy** (e.g.: FCC-hh)
 - **x10 improvement in LGADs radiation hardness**, up to $2.5E15$ Neq/cm², with R&D effort in ATLAS/CMS in **~6 years**
 - Need for **order of magnitude increase in radiation hardness and higher granularity**
- **Critical need to continue developing LGAD sensor technology** for far future applications
 - Why **5D**? Think of **extra information on Angle or Energy**
- **Lower power electronics and advanced integration** needs to be developed together with sensor R&D
- At the same time **pursue pure technology advancement: blue sky R&D**
 - **Applications in other fields** (X-ray detection, imaging, medical science, space, ...)

DJ-LGAD

TI-LGAD

High granularity

iLGAD

DS-LGAD

Buried-LGAD

Carbon implantation

FBK UFSD2, High Carbon

Compensated gain layer

Inactive Boron, Low diffusion...

Radiation hard

3D trenches

LGAD CMOS

?

Snowmass papers: [4D tracking paper](#), [CMOS](#), [Electronics](#), [SiC](#), [3D integr.](#)

Conclusions and R&D cost profile



- For **near-future applications AC-LGADs** seem to solve **granularity and power issue**
 - However, **many challenges lie ahead** in terms of high radiation damage and large occupancy
- There has been **great and fast development on 4/5-D detectors based on the LGAD technology** that makes it a **viable technology for short, medium and long term applications**
 - But **to fully meet the BRN goals** continuing funding for R&D is critical
 - Cost increment: **new technologies are progressively more complicated**

